

5A, 400V - 1000V Surface Mount Glass Passivated Rectifier

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Low forward voltage drop
- High surge current capability
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

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- Switching mode power supply (SMPS)
- Adapters
- Monitor
- TV

MECHANICAL DATA

- Case: DO-214AA (SMB)
- Molding compound meets UL 94V-0 flammability rating
- Moisture sensitivity level: level 1, per J-STD-020
- Packing code with suffix "G" means green compound (halogen-free)
- Part no. with suffix "H" means AEC-Q101 qualified
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.09 g (approximately)

KEY PARAMETERS					
PARAMETER VALUE UN					
I _{F(AV)}	5	Α			
V_{RRM}	400 - 1000	V			
T _{J MAX}	150	°C			
Package	DO-214AA (SMB)				
Configuration	Signal Die				





DO-214AA (SMB)

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)							
PARAMETER		SYMBOL	S5GB	S5JB	S5KB	S5MB	UNIT
Marking code on the device			S5GB	S5JB	S5KB	S5MB	
Repetitive peak reverse voltage		V_{RRM}	400	600	800	1000	V
Reverse voltage, total rms value		$V_{R(RMS)}$	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	400	600	800	1000	V	
Forward current	I _{F(AV)}	5			Α		
Surge peak forward current, 8.3 ms single half	T _J =25°C		200		Α		
sine-wave superimposed on rated load per diode	T _J =125°C	ı		150		Α	
Surge peak forward current, 1.0 ms single half	T _J =25°C	I _{FSM}	540		Α		
sine-wave superimposed on rated load per diode	T _J =125°C			290			Α
Junction temperature	TJ		- 55 to	+150		°C	
Storage temperature	T _{STG}	- 55 to +150			°C		



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THERMAL PERFORMANCE					
PARAMETER	SYMBOL	LIMIT	UNIT		
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	47	°C/W		
Junction-to-lead thermal resistance	$R_{\Theta JL}$	13	°C/W		

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT	
Forward voltage per diode (1)	I _F = 5A,T _J = 25°C	V_{F}	-	1.1	V	
Reverse current @ rated V _R per diode ⁽²⁾	T =25°C		-	10	μA	
Reverse current @ rated v _R per diode	T _J = 125°C	I _R	-	250	μA	
Junction capacitance	1 MHz, V _R =4V	CJ	40	-	pF	

Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

ORDERING INFORMATION							
PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX(*)	PACKAGE	PACKING		
		R5		SMB	850 / 7" Plastic reel		
S5xB (Note 1)	Н	R4	G	SMB	3,000 / 13" Paper reel		
(14016-1)		M4		SMB	3,000 / 13" Plastic reel		

Note:

1. "x" defines voltage from 400V (S5GB) to 1000V (S5MB)

^{*:} Optional available

EXAMPLE P/N					
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
S5GBHR5G	S5GB	Н	R5	G	AEC-Q101 qualified Green compound



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig1. Forward Current Derating Curve

6 AVERAGE FORWARD CURRENT (A) 5 4 3 2 1 RESISTIVE OR INDUCTIVE LOAD 0 0 25 50 75 100 125 150 LEAD TEMPERATURE (°C)

Fig2. Typical Junction Capacitance

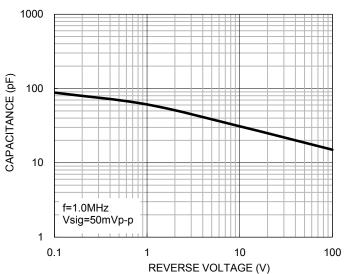


Fig3. Typical Reverse Characteristics

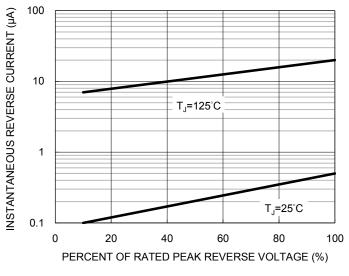
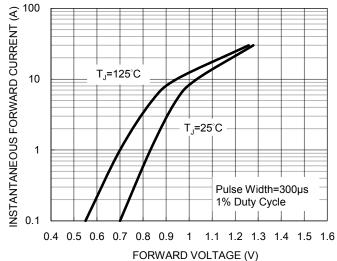


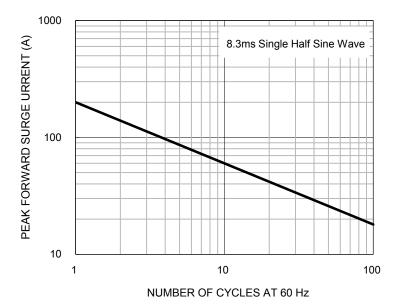
Fig4. Typical Forward Characteristics



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Fig5. Maximum Non-repetitive Forward Surge Current

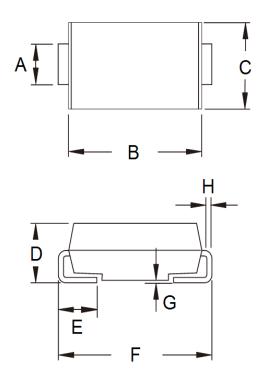


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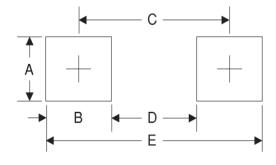
PACKAGE OUTLINE DIMENSIONS

DO-214AA (SMB)



DIM.	Unit	(mm)	Unit (inch)	
DIIVI.	Min	Max	Min	Max
Α	1.95	2.20	0.077	0.087
В	4.05	4.60	0.159	0.181
С	3.30	3.95	0.130	0.156
D	1.95	2.65	0.077	0.104
Е	0.75	1.60	0.030	0.063
F	5.10	5.60	0.201	0.220
G	0.05	0.20	0.002	0.008
Н	0.15	0.31	0.006	0.012

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
А	2.3	0.091
В	2.5	0.098
С	4.3	0.169
D	1.8	0.071
E	6.8	0.268

MARKING DIAGRAM



P/N = Marking Code
G = Green Compound
YW = Date Code
F = Factory Code





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